



## Description

# JMTP170C04D

## JMT N And P-Channel Enhancement Mode MOSFET

### Features

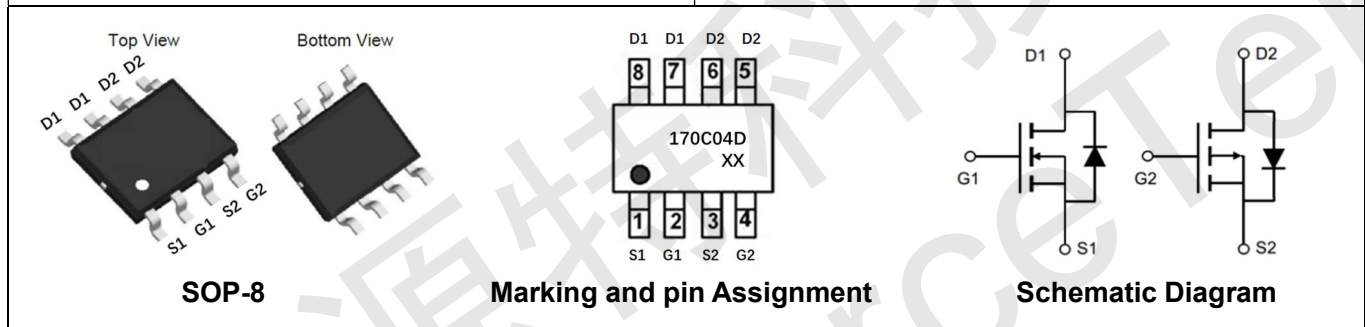
- N-Channel: 40V, 10A  
 $R_{DS(ON)} < 20m\Omega @ V_{GS} = -10V$   
 $R_{DS(ON)} < 27m\Omega @ V_{GS} = -4.5V$
- P-Channel: -40V, -10A  
 $R_{DS(ON)} < 44m\Omega @ V_{GS} = -10V$   
 $R_{DS(ON)} < 62m\Omega @ V_{GS} = -4.5V$
- Excellent Gate Charge x  $R_{DS(ON)}$  Product(FOM)
- Very Low On-resistance  $R_{DS(ON)}$
- Fast Switching Speed

### Application

- Battery Protection
- Load Switch
- Power Management



100% UIS TESTED!  
100%  $\Delta V_{ds}$  TESTED!



## Package Marking and Ordering Information

Device Marking	Device	OUTLINE	Device Package	Reel Size	Reel (PCS)	Per Carton (PCS)
170C04D	JMTP170C04D	TAPING	SOP-8	13inch	4000	48000

## Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise specified)

Symbol	Parameter	Max. N-Channel	Max. P-Channel	Units
$V_{DSS}$	Drain-Source Voltage	40	-40	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	$\pm 20$	V
$I_D$	Continuous Drain Current	$T_A = 25^\circ C$	-10	A
		$T_A = 100^\circ C$	-6.5	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>	40	-40	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>note2</sup>	19	27.5	mJ
$P_D$	Power Dissipation	3.4	7.5	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	36.8	16.7	$^\circ C/W$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150		$^\circ C$

Version :1.0



# JMTP170C04D

## N-Channel Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	-	-	1.0	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.5	2.5	V
R <sub>DS(on)</sub>	Static Drain-Source on-Resistance note3	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	-	15	20	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A	-	19	27	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V, f=1.0MHz	-	980	-	pF
C <sub>oss</sub>	Output Capacitance		-	86.2	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	68.5	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =20V, I <sub>D</sub> =5A, V <sub>GS</sub> =10V	-	11	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	1.9	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	2.2	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DS</sub> =20V, I <sub>D</sub> = 5A, R <sub>L</sub> =2.5Ω, R <sub>REN</sub> =3Ω	-	11	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	13	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time		-	36	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	9	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	10	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	40	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = 10A	-	-0.8	-1.2	V
t <sub>rr</sub>	Body Diode Reverse Recovery Time	T <sub>J</sub> =25°C,	-	19	-	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery	I <sub>F</sub> =10A, di/dt=100A/μs	-	11	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition : T<sub>J</sub>=25°C, V<sub>DD</sub>=30V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω, I<sub>AS</sub>=8.7A

T<sub>J</sub>=25°C, V<sub>DD</sub>=-30V, V<sub>G</sub>= -10V, L=0.5mH, R<sub>g</sub>=25Ω, I<sub>AS</sub>= -10.5A

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

Version : 1.0



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## P-Channel Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise specified)

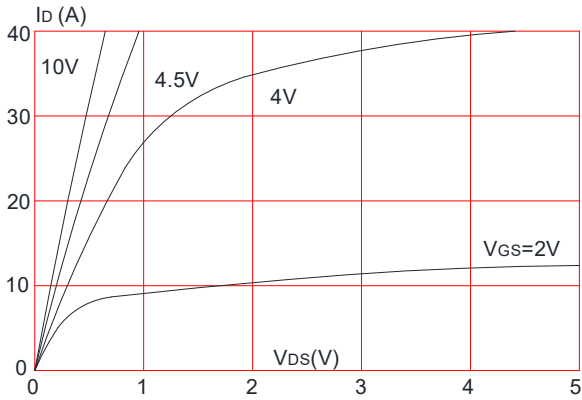
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> = -250μA	-40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -40V, V <sub>GS</sub> =0V	-	-	-1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.0	-1.6	-2.5	V
R <sub>DS(on)</sub>	Static Drain-Source on-Resistance <small>note3</small>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -8A	-	34	44	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -5A	-	46	62	
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V, f=1.0MHz	-	1034	-	pF
C <sub>oss</sub>	Output Capacitance		-	107	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	79.5	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = -20V, I <sub>D</sub> = -5A, V <sub>GS</sub> = -10V	-	20	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	3.5	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge		-	4.2	-	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> = -20V, I <sub>D</sub> = -5A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> =2.5Ω	-	8	-	ns
t <sub>r</sub>	Turn-on Rise Time		-	15	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time		-	23	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	9	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	-10	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-40	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = -10A	-	-0.8	-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>J</sub> =25 °C	-	29	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =10A, di/dt=100A/μs	-	20	-	nC



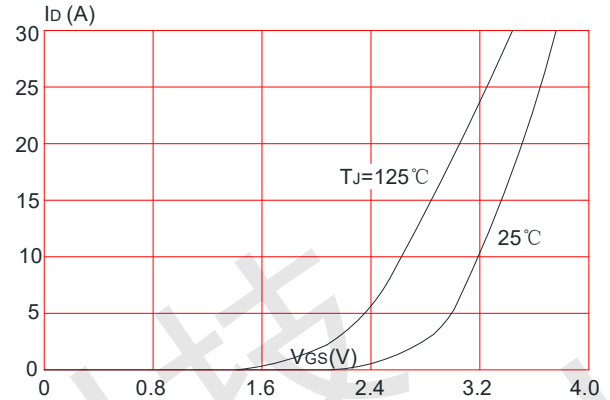
# JMTP170C04D

## Typical Performance Characteristics-N

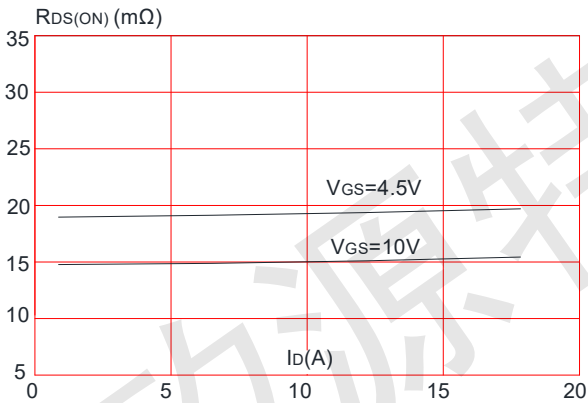
**Figure 1: Output Characteristics**



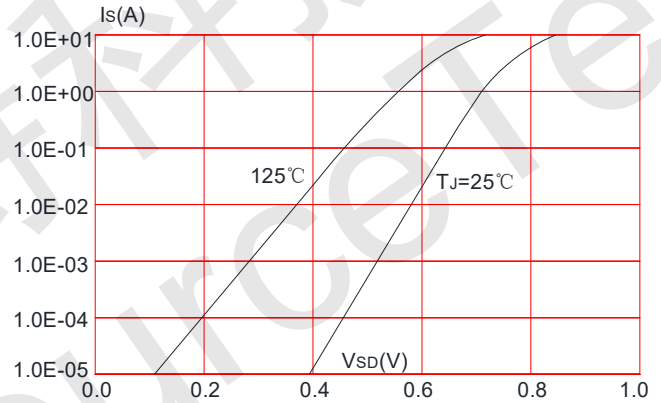
**Figure 2: Typical Transfer Characteristics**



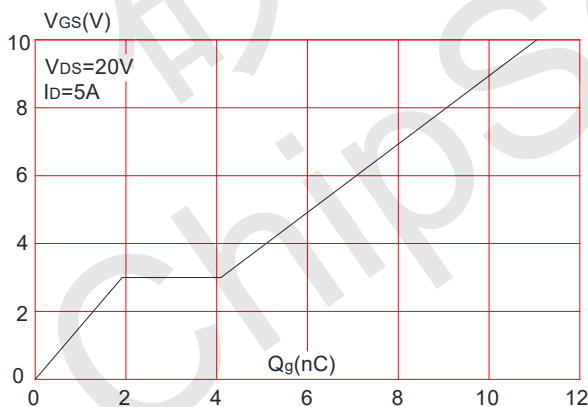
**Figure 3: On-resistance vs. Drain Current**



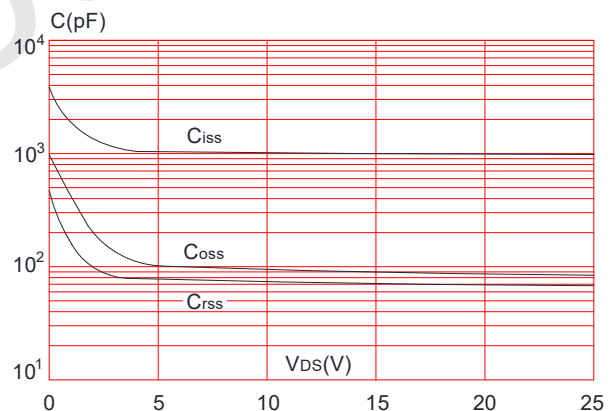
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**



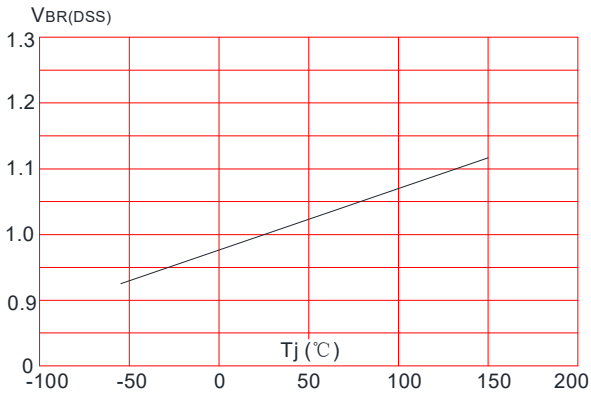
**Figure 6: Capacitance Characteristics**



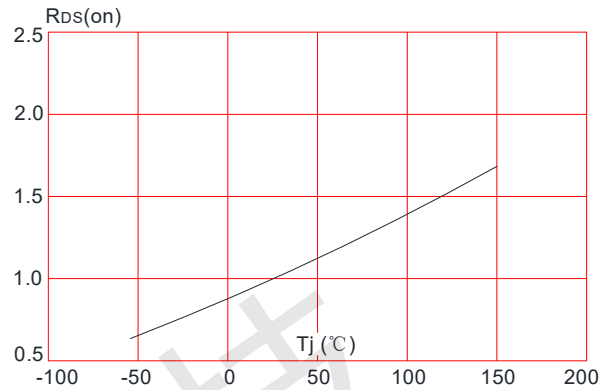


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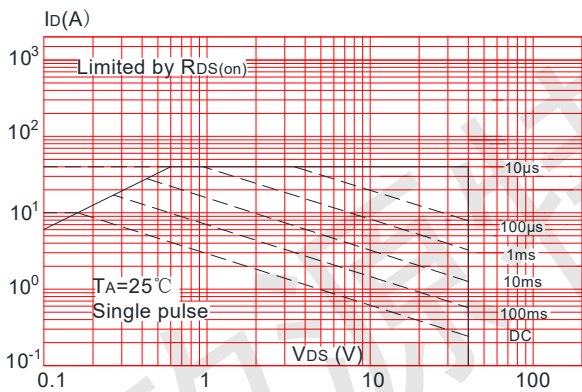
**Figure 7: Normalized Breakdown Voltage vs. Junction Temperature**



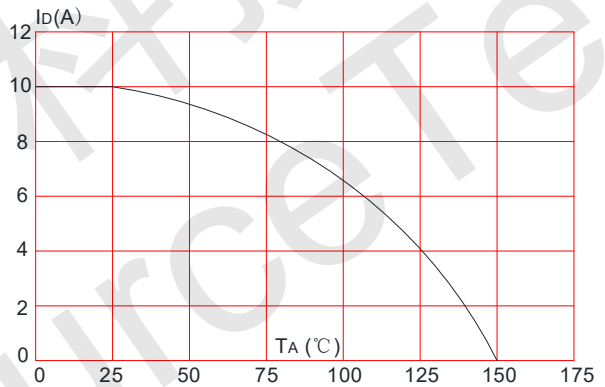
**Figure 8: Normalized on Resistance vs. Junction Temperature**



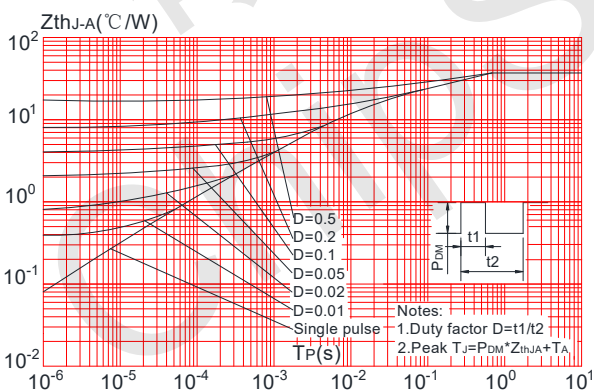
**Figure 9: Maximum Safe Operating Area**



**Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature**



**Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient**





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## Test Circuit-N

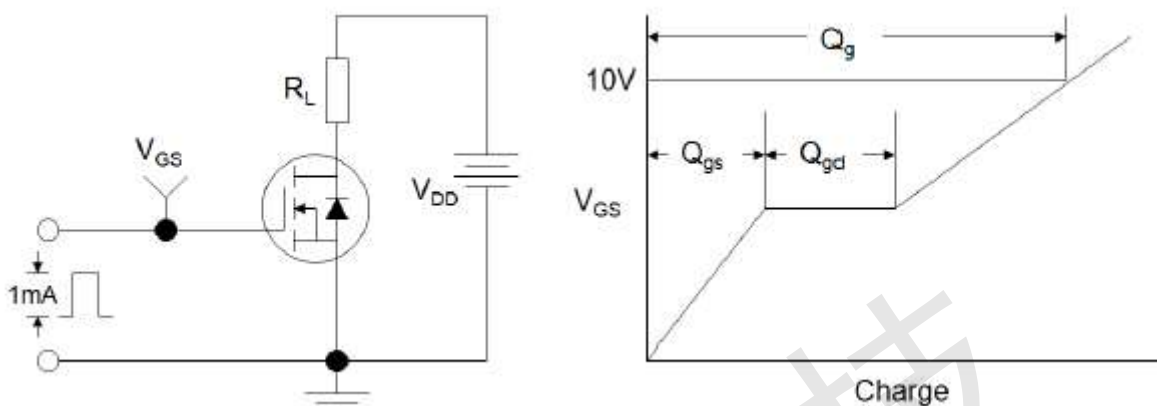


Figure1:Gate Charge Test Circuit & Waveform

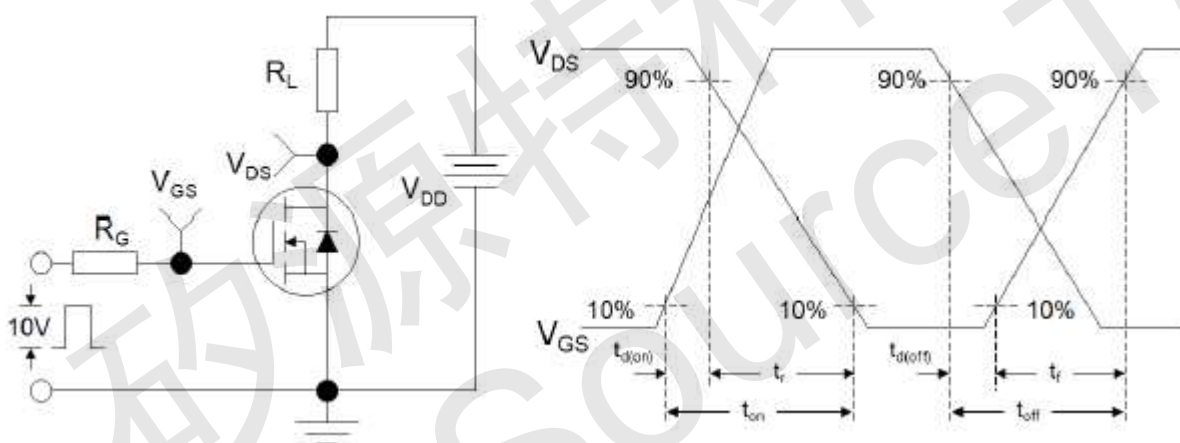


Figure 2: Resistive Switching Test Circuit & Waveforms

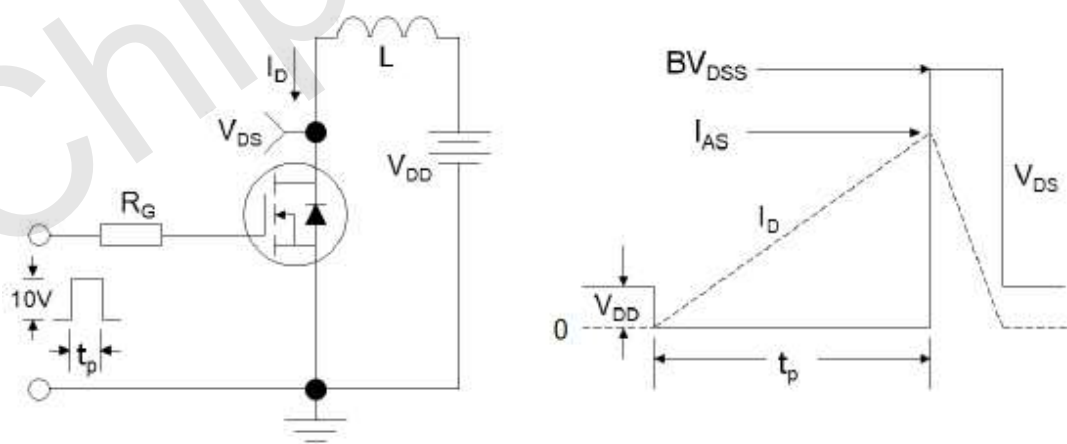


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms

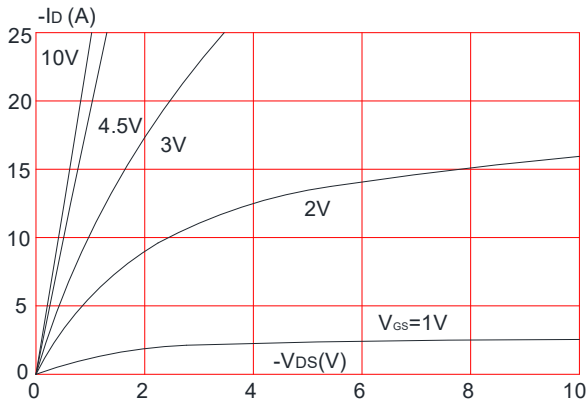




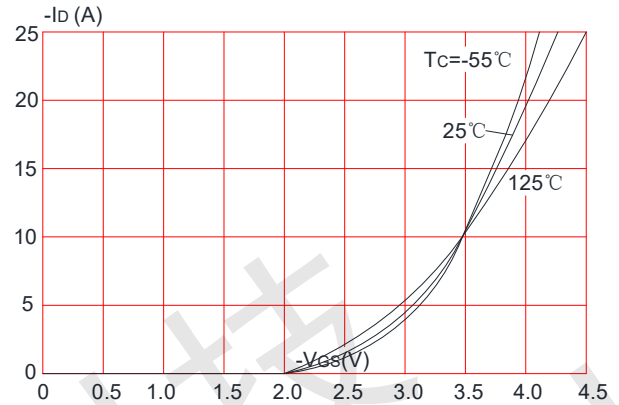
# JMTP170C04D

## Typical Performance Characteristics-P

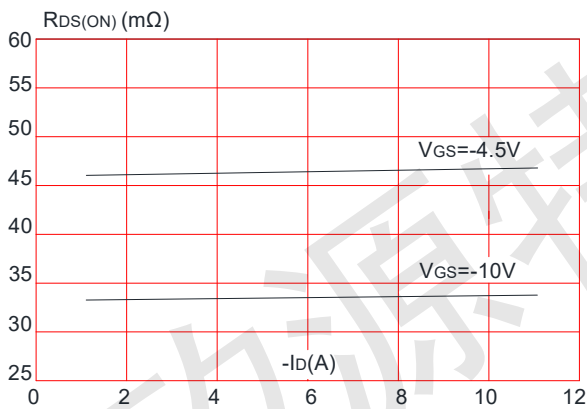
**Figure 1: Output Characteristics**



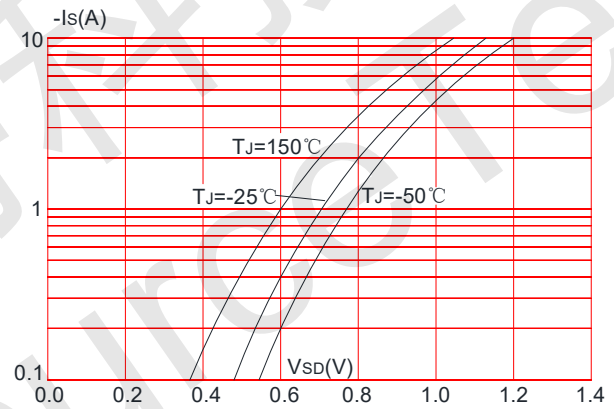
**Figure 2: Typical Transfer Characteristics**



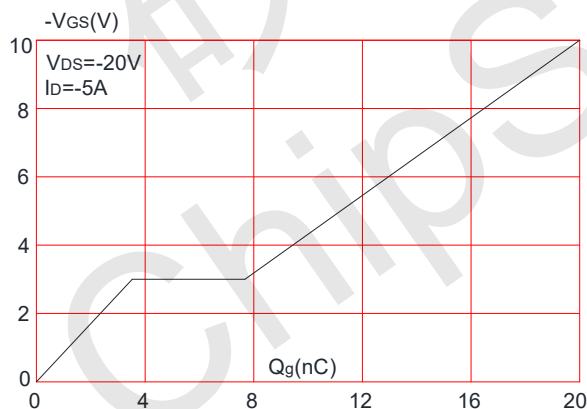
**Figure 3: On-resistance vs. Drain Current**



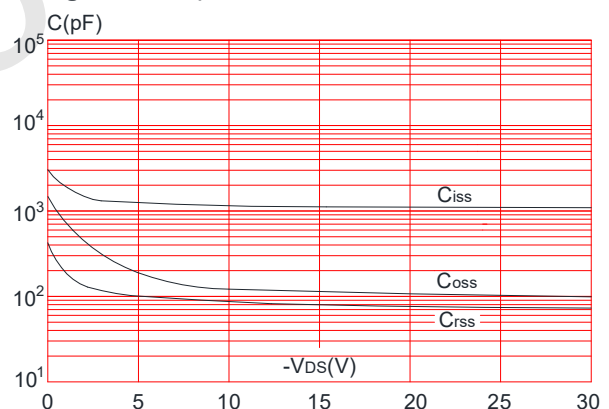
**Figure 4: Body Diode Characteristics**



**Figure 5: Gate Charge Characteristics**



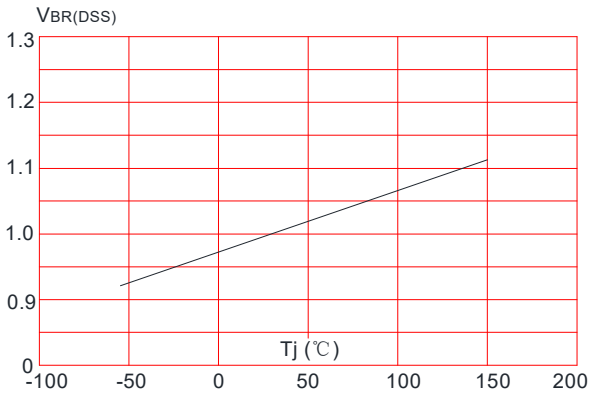
**Figure 6: Capacitance Characteristics**



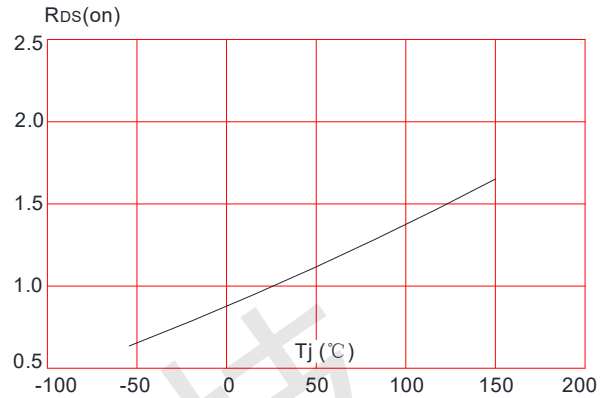


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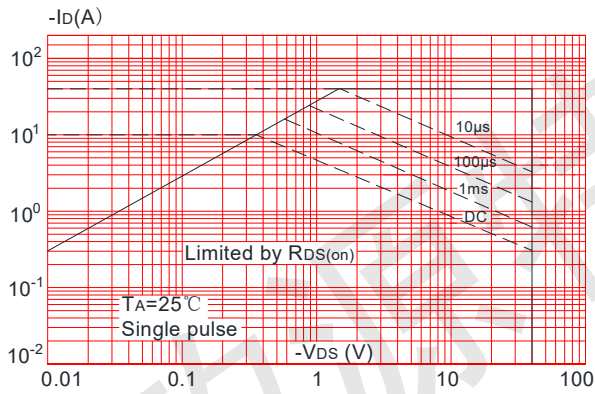
**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature



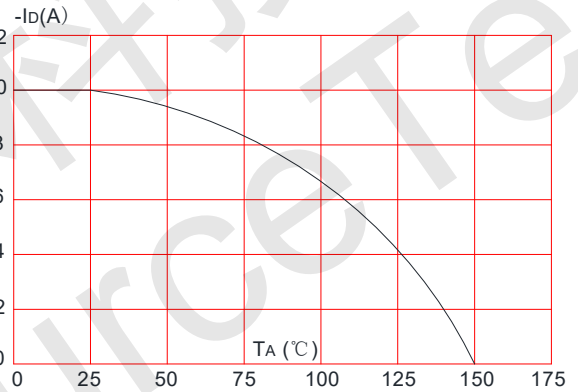
**Figure 8:** Normalized on Resistance vs. Junction Temperature



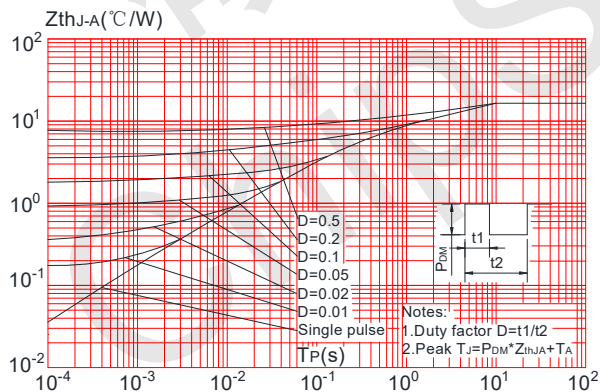
**Figure 9:** Maximum Safe Operating Area



**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature



**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



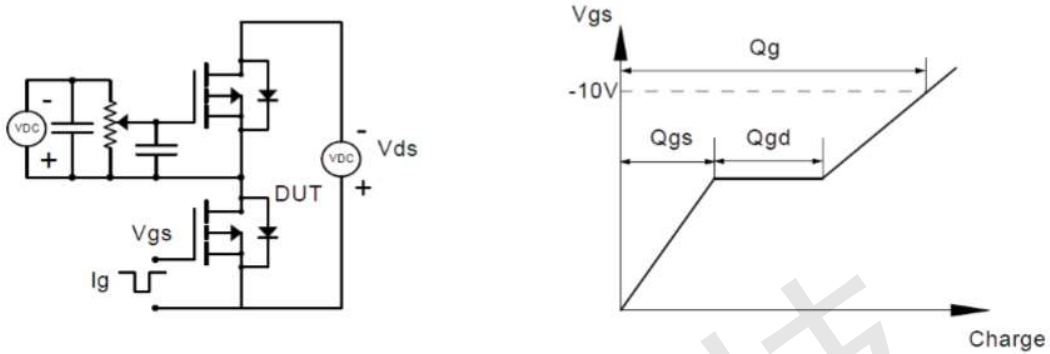




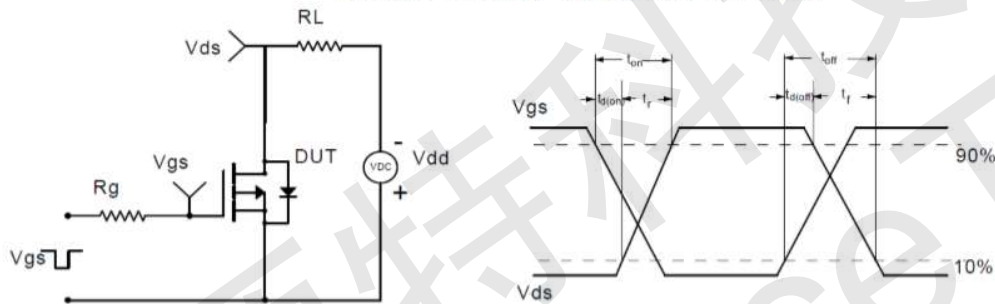
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## Test Circuit-P

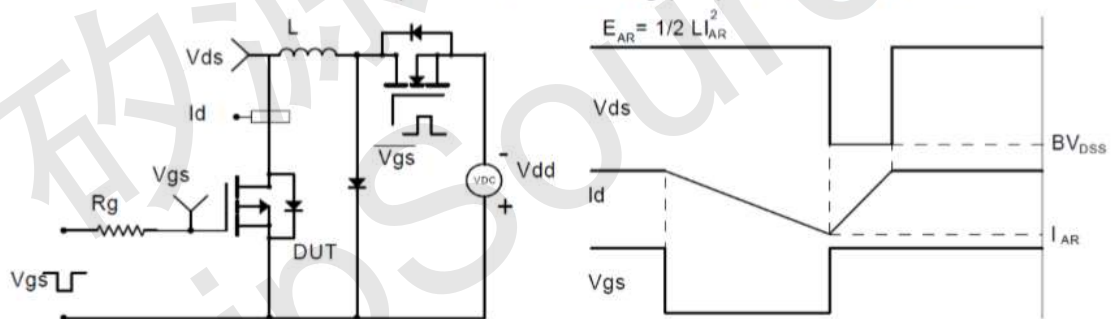
Gate Charge Test Circuit & Waveform



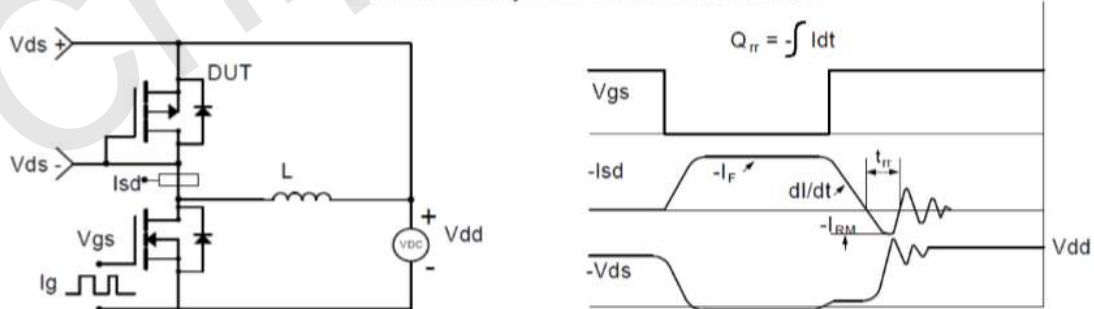
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms





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## Package Mechanical Data-SOP-8

